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Analyzing nanotextured transparent conductive oxides for efficient light trapping in silicon thin film solar cells

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Nanotextured contact layers are used in silicon thin film solar cells for increasing the short circuit current and conversion efficiency. We developed an approach to analyze random nanotextured surfaces by atomic force microscopy and image segmentation. It was used to investigate sputtered and wet chemically etched aluminum doped zinc oxide films with various morphologies. The information extracted from the surfaces was correlated with optical simulations of periodically textured thin film solar cells. The results from the surface analysis and optical simulations were also compared with the experimental results obtained for amorphous silicon solar cells prepared on the nanotextured substrates.

Light-trapping in thin film solar cells allows for both a reduction of the reflection losses and an increase in the optical path length of the incident light inside the solar cell. Different light trapping methods have been proposed for increasing the absorption of light in thin film solar cells. It has been demonstrated that introducing randomly textured interfaces is a very effective approach for increasing the absorption of light in thin film solar cells. Light is diffracted and scattered upon entering the solar cell, leading to an increase of the short circuit current and conversion efficiency. Randomly textured surfaces can be fabricated by wet etching of sputtered zinc oxide films, or during deposition by low pressure chemical vapor deposition (LPCVD) of zinc oxide or tin oxide. The surface of the sputtered and subsequently etched zinc oxide film is characterized by a random arrangement of craters, while the surface of the low pressure chemical vapor deposited film can be described by a random arrangement of pyramids. Characterization and optimization of randomly textured surfaces is complex. Various approaches have been suggested to characterize and optimize the substrates, including optical measurements of the haze, which is given by the ratio of the diffuse and total (specular plus diffuse) transmitted light. Furthermore, measurements of the angular distribution function (ADF) have been carried out to gain insights into the diffraction and scattering behavior of nanotextured surfaces. These measurements, however, cannot be directly correlated with solar cell parameters like the quantum efficiency or the short circuit current. Alternative approaches have been presented by several authors using direct measurements of the nanotextured surfaces by atomic force microscopy (AFM). Dominé et al. and Bittkau et al. treated the textured surface as a phase mask. By calculating the Fourier transform of the AFM images, the scattering properties can be determined. Franken et al. characterized the surface by calculating the power spectral density function, which is given by the Fourier transform of the autocorrelation function of the AFM images. Stiebig et al. suggested an approach to calculate the opening angle of the craters by analyzing the textured surface. All approaches, however, provide only limited information on the wave propagation of light in a nanotextured thin film solar cell. The extracted parameters do not allow for a complete description of the nanotextured surface. Therefore, they cannot be directly correlated with the quantum efficiency and short circuit current of a solar cell prepared on a nanotextured surface.

We have developed an alternative approach that uses image segmentation techniques to analyze AFM images and extract the dimensions of individual craters or pyramids on the surface. The extracted dimensions were correlated with optical simulations of the wave propagation in solar cells with inverted pyramid (crater-like) textures. The combination of the surface analysis and the optical simulations can be used to derive design rules for optimization of the surface texture. The results of the approach are confirmed by experimental results of amorphous silicon solar cells prepared on nanotextured surfaces.

The textured zinc oxide films were prepared by radio frequency (rf) magnetron sputtering in an in-line sputtering system at 300 °C substrate temperature. Films were subsequently etched in diluted hydrochloric (HCl, 0.5 w/w %) and hydrofluoric (HF, 1 w/w %) acid solutions for 50 and 75 s, respectively. SEM images of the zinc oxide films, textured by HCl and HF, are shown in Fig. 2. A comparison of the SEM images reveals that the HCl etched film, as shown in Fig. 2(a), is characterized by fewer but larger craters. The HF etched film in Fig. 2(b) exhibits a larger number of smaller craters. The difference in the samples can be explained by the differences in the etching properties of HF and HCl. HF molecules are smaller in size than almost all other acid molecules (including HCl), this combined with...
the weak dissociation constant enables HF molecules to penetrate deeper and into more polycrystalline zinc oxide grain boundaries before dissociating and subsequently etching. In order to allow for a 3D analysis of the textured films, the surfaces were characterized by AFM. The individual craters on the zinc oxide surfaces were separated by an image segmentation algorithm applied to AFM data. The algorithm first finds all local minima (crater tips) and then subsequently determines the corresponding surrounding borders. The segmentation is illustrated in Figs. 2(c) and 2(d), where the borders of the individual craters are marked by black lines and the minima (tips) of the craters are marked by white points.

The crater-like surface of the zinc oxide films can be approximated by inverted cones. However, full surface coverage cannot be achieved using inverted cones with a circular base. Therefore, to ensure full surface coverage, the inverted cones were mapped to inverted pyramids with a hexagonal base. As shown in Fig. 1(b), the dimensions of the pyramids can be described by the diameter $D$ and depth $d$. From the distributions of the diameters and depths of the inverted pyramids, it was found that the HCl-etched sample exhibits a wide range of diameters. Eighty-five percent of all inverted pyramids on the surface have diameters in the range of 0.5–1.9 μm. On the other hand, the HF-etched sample has a much narrower diameter distribution. More than 95% of the inverted pyramids have diameters in the range of 0.2–0.8 μm. The depth distributions of the HCl etched sample and HF-etched sample were similar. Most of the inverted pyramids on both surfaces have depths in the range of 50–400 nm. In the case of the HCl-etched surface, there are deeper craters that go beyond 400 nm and 17% of the inverted pyramids have depths between 400 nm and 800 nm.

In order to determine the optimal dimensions of the surface texture, optical simulations of amorphous silicon thin film silicon solar cells with integrated inverted pyramid texture were carried out. The 3D optical wave propagation in the solar cell was investigated by rigorously solving Maxwell’s equations using finite difference time domain (FDTD) algorithm. FDTD is a numerically fast and robust technique, which is widely used in optical simulations for photovoltaic devices. The schematic cross section of an amorphous silicon solar cell on a nanotextured substrate is shown in Fig. 1(a). We assumed that the randomly textured surface can be approximated by a periodic surface structure. Haase et al. have shown that the short circuit current density of a solar cell on a quasi random substrate can be approximated as the area weighted superposition of the short circuit current density for solar cells with periodic surface texture.

A unit cell of the periodically textured amorphous solar cell is shown in Fig. 3(a). The layer sequence of the amorphous silicon solar cell consists of an 800 nm thick aluminum-doped zinc oxide (ZnO:Al) front contact. Afterwards, the inverter pyramids (craters) were etched in the zinc oxide film. The periodic surface texture can be described by pyramid diameter ($D$) and depth ($d$) as shown in Fig. 3(a). In this study, the...
pyramid period and height were varied from 50 nm to 3000 nm and 0 nm to 500 nm, respectively. The front contact layer was followed by a hydrogenated amorphous silicon p-i-n diode (a-Si:H), which has a total thickness of 400 nm with p- and n-layer thicknesses of 10 nm. The back reflector consists of an 80 nm thick ZnO:Al layer and a perfect metal reflector. The complex optical constants of the individual layers were determined by transmission, reflection, and ellipsometry measurements of the individual layers. The simulations were executed by illuminating the unit cell under normal incidence for wavelengths ranging from 300 nm to 800 nm. In the first step, the electric field distribution was calculated for the layer sequences. Then, the time average power loss was calculated. Figs. 3(b) and 3(c) show the cross sectional power loss maps of the investigated structure for textured solar cells with a crater depth of 200 nm and diameters of 400 nm and 900 nm. The wavelength of the incident light was 700 nm for both the cases. Since this wavelength is close to the optical bandgap of amorphous silicon, the light is reflected and scattered by the front and back gratings. For small periods (p ≤ 150 nm) of the inverted crater, the optical propagation can be described with effective medium theory. In such cases, the textured interface acts as matched layer in between the zinc oxide and the silicon layers. The power loss profile for a unit cell period of 400 nm [Fig. 3(b)] exhibits the regions of high absorption. For a larger period of 900 nm [Fig. 3(c)], the light is scattered in smaller angles and the average absorption in the unit cell drops.

The quantum efficiency was then calculated. The quantum efficiency is defined as the ratio of the power absorbed by the absorber (i-layer) of the solar cell to the total power incident on the solar cell. Finally, the short circuit current density was calculated for the spectral irradiance of Air Mass 1.5 (AM 1.5). Additional details on how to calculate time average power loss, quantum efficiency, and short circuit current density are given in Ref. 19. The simulated short circuit current density map of an amorphous thin film solar cell as a function of the inverted pyramid diameter and depth is shown in Fig. 4. The total thickness of the p-i-n diode was assumed to be 400 nm. A solar cell without a surface texture (smooth ZnO substrate) exhibits a short circuit density of 13.5 mA/cm². The highest short circuit current density of 14.1 mA/cm² is observed for an inverted pyramid with diameter of 500 nm and depth of 500 nm. This corresponds to more than 25% gain in the short circuit current density.

In Fig. 4(a), the short circuit current density map is overlaid with lines presenting different opening angles of the inverted pyramids. The short circuit current density increases substantially for opening angles smaller than 90°. The highest short circuit currents are achieved for opening angles between 30° and 60°. The short circuit current density map, in Fig. 4(b), is overlaid with data points representing the crater dimensions (diameter and depth) of the zinc oxide films patterned by HCl and HF. We assume that the diameter of the unit cell in the optical simulation is equal to the diameter of the crater extracted from the AFM images. The distributions of the craters for the two substrates can be fitted by lines. The opening angle of the HF textured is approximately equal to 70°. Small and big craters have almost identical opening angles. The situation is different for samples textured by HCl. For small craters, the opening angle approaches 140°. With increasing dimensions of the craters, the opening angle reduces to 120°. Therefore, the opening angle of the HCl substrate is comparable to the opening angles of craters etched into single crystal zinc oxide wafers. A comparison of the data points for the two substrates with the simulated short circuit current density shows that the area weighted superposition of short circuit current density is higher for the HF etched sample.

The observation from the simulation results is also confirmed by the experimental results. Thin film amorphous silicon solar cells were prepared on zinc oxide thin films etched in 0.5 w/w % HCl, and 1.0 w/w % HF. Etching times were adjusted such that approximately 150 nm of the originally 800 nm thick films were removed, as determined by surface profiler. The amorphous silicon p-i-n solar cells were prepared by plasma enhanced chemical vapor deposition (PECVD) at deposition temperatures below 200 °C. The intrinsic layer of the solar cell has a thickness of about 400 nm. The p- and the n-layers have a thickness of about 10 nm. The measured short circuit current densities of the solar cells are tabulated in Table I. The amorphous silicon solar cell prepared on the HCl textured substrate exhibited a short circuit current density of 14.1 mA/cm², while the HF textured substrate resulted in a short circuit current density of 15.4 mA/cm². The fill factor and open circuit voltage of the solar cells were approximately 70% and 900 mV, resulting in conversion efficiencies of almost 10%. As a reference to these values, a solar cell prepared on a smooth substrate exhibits a short circuit current of 12.5 mA/cm². A summary of the measured and calculated short circuit current densities...
Further quantum efficiency curves and I-V data of the prepared solar cells are provided as supplementary information.23

Determining optimal light trapping structures is complex. The experimental description and characterization of randomly textured surfaces is in most cases based on the measurements of parameters like the haze in transmission or the angle dependent distribution of light scattering. However, these parameters provide only statistical information on the substrate and do not take into account the exact morphology of the surface. The approach presented here allows for the extraction of individual dimensions of craters or pyramids on a surface. Furthermore, the extracted parameters can be correlated with numerical simulation of solar cells with integrated surface textures.

The experimental results in Table I show that HF etched zinc oxide substrates exhibit higher short circuit currents than those of HCl etched substrates. In order to further increase the short circuit current, the opening angle of the surface texture has to be reduced further. Short wavelengths (<500 nm) are absorbed within the first few nanometers of the solar cell. Due to the large optical bandgap (1.7 eV) of amorphous silicon, wavelengths ranging from 500 nm to 800 nm have to be efficiently diffracted and scattered. The optimal surface textures exhibit periods in the range of 250 nm–300 nm. For microcrystalline silicon thin film solar cells, the optimal surface texture increases to approximately 1000 nm.24 For the HCl substrate, an average diameter and depth of the inverted pyramid of 900 nm and 200 nm can be estimated. As shown in Table I, the calculated short circuit current density for the periodic structure with such dimension is 15.5 mA/cm². On the other hand, the average diameter and the depth of the HF etched substrate are estimated to be 400 nm and 200 nm. For solar cells with such inverted pyramid dimension, the short circuit current increases up to 17.2 mA/cm². The optical simulations represent an upper limit of the short circuit current. The lower experimental short circuit current density can be attributed to non-ideal structure dimensions and to electrical losses in the solar cell. The next step is to extend the model so that the short circuit current density of solar cells can be directly calculated based on the measured surface profile.

In summary, an approach that allows the characterization and optimization of surface textures for thin film silicon solar cells was presented. Wet chemical etching of the contact layers can be used to control the scattering and diffraction of the incident light, such that the short circuit current and the conversion efficiency are maximized. We developed an approach that allows the extraction of the important surface parameters from atomic force microscope images. The extracted information of the randomly textured surfaces can be correlated with optical simulations of periodically textured thin film solar cells, so that optimized surface textures can be derived. The analysis was verified by experimental results. Amorphous silicon solar cells prepared on the optimized surface texture exhibited short circuit current densities of 15.4 mA/cm². This corresponds to almost 25% gain as compared to a solar cell prepared on a smooth substrate, yielding conversion efficiencies of almost 10%.

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<tr>
<th>Smooth substrate</th>
<th>HCl etched ZnO</th>
<th>HF etched ZnO</th>
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<tbody>
<tr>
<td>12.5 mA/cm²</td>
<td>14.1 mA/cm²</td>
<td>15.4 mA/cm²</td>
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<th>Calculated short circuit current density from simulations</th>
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<tr>
<td>D = 900 nm, d = 200 nm</td>
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<td>D = 400 nm, d = 200 nm</td>
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